SDAS198B - APRIL 1982 - REVISED AUGUST 1995

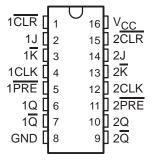
 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY (MHz)	TYPICAL POWER DISSIPATION PER FLIP-FLOP (mW)
'ALS109A	50	6
'AS109A	129	29

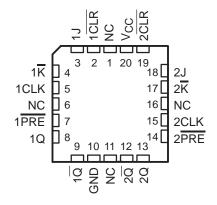
description

These devices contain two independent J-K positive-edge-triggered flip-flops. A low level at the preset (PRE) or clear (CLR) inputs sets or resets the outputs regardless of the levels of the other inputs. When PRE and CLR are inactive (high), data at the J and \overline{K} inputs meeting the setup-time requirements are transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the J and \overline{K} inputs can be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by grounding \overline{K} and tying J high. They also can perform as D-type flip-flops if J and \overline{K} are tied together.

SN54ALS109A, SN54AS109A . . . J PACKAGE SN74ALS109A, SN74AS109A . . . D OR N PACKAGE (TOP VIEW)



SN54ALS109A, SN54AS109A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54ALS109A and SN54AS109A are characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS109A and SN74AS109A are characterized for operation from 0°C to 70°C.

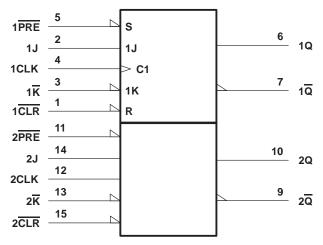
FUNCTION TABLE

		INPUTS			OUTI	PUTS
PRE	CLR	CLK	J	K	Q	Ø
L	Н	Х	Χ	Χ	Н	L
Н	L	X	Χ	X	L	Н
L	L	X	Χ	X	H [†]	H [†]
Н	Н	\uparrow	L	L	L	Н
Н	Н	\uparrow	Н	L	Tog	gle
Н	Н	\uparrow	L	Н	Q0	Q0
Н	Н	\uparrow	Н	Н	Н	L
Н	Н	L	Χ	Χ	Q0	Q0

† The output levels in this configuration are not specified to meet the minimum levels for V_{OH} if the lows at PRE and CLR are near V_{IL} maximum. Furthermore, this configuration is nonstable; that is, it does not persist when either PRE or CLR returns to its inactive (high) level.

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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	7 V
Input voltage, V _I	7 V
Operating free-air temperature range, T _A : SN54ALS109A	. -55°C to 125°C
SN74ALS109A	0°C to 70°C
Storage temperature range	65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN	54ALS10	9A	SN7	'4ALS10	9A	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
lOH	High-level output current				-0.4			-0.4	mA
lOL	Low-level output current				4			8	mA
fclock	Clock frequency		0		30	0		34	MHz
		PRE or CLR low	15			15			
t _W	Pulse duration	CLK high	16.5			14.5			ns
		CLK low	16.5			14.5			
	Cation times before CLIVA	Data	15			15			
t _{su}	Setup time before CLK↑	PRE or CLR inactive	10			10			ns
t _h	Hold time after CLK↑	Data	0			0			ns
TA	Operating free-air temperature		-55		125	0		70	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				SN5	4ALS10	9A	SN7	4ALS10	9A	
P	ARAMETER	TEST CO	NDITIONS	MIN	TYP [†]	MAX	MIN	TYP†	MAX	UNIT
٧ıK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.5			-1.5	V
VOH		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2			V _{CC} -2			V
.,		45.7	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	
VOL		V _{CC} = 4.5 V	$I_{OL} = 8 \text{ mA}$					0.35	0.5	٧
	CLK, J, or K	V 55V	V 7V			0.1			0.1	Λ
1	PRE or CLR	$V_{CC} = 5.5 \text{ V},$	V _I = 7 V			0.2			0.2	mA
	CLK, J, or K	V 55V	V 07V			20			20	^
lН	PRE or CLR	V _{CC} = 5.5 V,	V _I = 2.7 V			40			40	μΑ
	CLK, J, or K					-0.2			-0.2	
IIL	PRE or CLR	V _{CC} = 5.5 V,	$V_{I} = 0.4 V$			-0.4			-0.4	mA
lo [‡]		V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
ICC		$V_{CC} = 5.5 \text{ V},$	See Note 1		2.4	4		2.4	4	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω , T_A = MIN to MAX§		UNIT		
	, ,	, ,	SN54AL	S109A	SN74AL	S109A	
			MIN	MAX	MIN	MAX	
f _{max}			30		34		MHz
t _{PLH}	PRE or CLR	0	3	17	3	13	
t _{PHL}	PRE OF CLR	Q or Q	5	17	5	15	ns
t _{PLH}	CLK	Q or Q	5	21	5	16	ns
^t PHL	OLK	QUIQ	5	20	5	18	110

[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[†] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, Ios. NOTE 1: I_{CC} is measured with J, K, CLK, and PRE grounded, then with J, K, CLK, and CLR grounded.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}		 	7 V
Input voltage, V _I		 	7 V
Operating free-air temperature range, T _A :	SN54AS109A	 	-55°C to 125°C
	SN74AS109A	 	0°C to 70°C
Storage temperature range			-65°C to 150°C

recommended operating conditions

			SN	54AS10	9A	SN	74AS109	9A	LINUT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.8			8.0	V
ЮН	High-level output current				-2			-2	mA
l _{OL}	Low-level output current				20			20	mA
fclock*	Clock frequency		0		90	0		105	MHz
		PRE or CLR low	4			4			
tw*	Pulse duration	CLK high	4			4			ns
		CLK low	5.5			5.5			
. *	Octor than before OLIVA	Data	5.5			5.5			
t _{su} *	Setup time before CLK↑	PRE or CLR inactive	2			2			ns
th*	Hold time after CLK↑	Data	0			0			ns
TA	Operating free-air temperature		-55		125	0		70	°C

^{*} On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DAMETER	TF0T 00	NIDITIONS	SN	54AS109)A	SN	74AS109	A	LINIT
PA	RAMETER	TEST CO	NDITIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK		V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
Vон		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2			V _{CC} -2			V
VOL		$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 20 \text{ mA}$		0.25	0.5		0.25	0.5	V
lį		$V_{CC} = 5.5 \text{ V},$	$V_I = 7 V$			0.1			0.1	mA
	CLK, J, or K	V 55V	V 07V			20			20	^
^I IH	PRE or CLR	$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			40			40	μΑ
	CLK, J, or K	V 55V	V 04V			-0.5			-0.5	4
IIL	PRE or CLR	V _{CC} = 5.5 V,	$V_{I} = 0.4 V$			-1.8			-1.8	mA
IO§		V _{CC} = 5.5 V,	$V_0 = 2.25 \text{ V}$	-30		-112	-30		-112	mA
ICC		V _{CC} = 5.5 V,	See Note 1		11.5	17		11.5	17	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS. NOTE 1: ICC is measured with J, K, CLK, and PRE grounded, then with J, K, CLK, and CLR grounded.

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switching characteristics (see Figure 1)

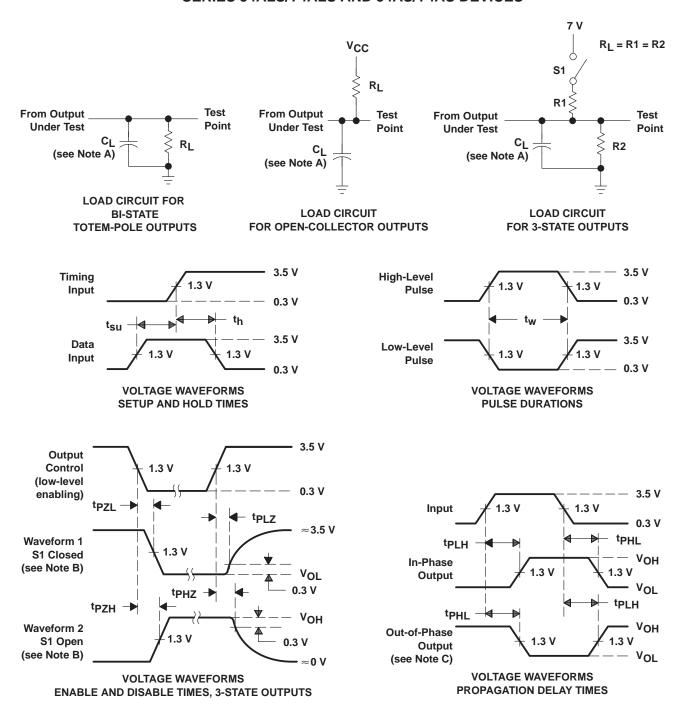
PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L = 50 R _L = 50		V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω, T_A = MIN to MAX†		UNIT
	, ,	, ,	SN54A	S109A	SN74A	S109A	
			MIN	MAX	MIN	MAX	
f _{max} *			90		105		MHz
t _{PLH}	PRE or CLR	Q or Q	2	9	2	8	20
t _{PHL}	PRE OF CLR	Q or Q	3.5	11.5	3.5	10.5	ns
t _{PLH}	CLK	Q or Q	2.5	10	2.5	9	ns
t _{PHL}	OLK	QUIQ	3.5	10.5	3.5	9	115

^{*} On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: $PRR \le 1$ MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
84000012A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	84000012A SNJ54ALS 109AFK
8400001EA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8400001EA SNJ54ALS109AJ
JM38510/37102B2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37102B2A
JM38510/37102B2A.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37102B2A
JM38510/37102BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37102BEA
JM38510/37102BEA.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37102BEA
M38510/37102B2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37102B2A
M38510/37102BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37102BEA
SN54ALS109AJ	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54ALS109AJ
SN54ALS109AJ.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54ALS109AJ
SN74ALS109AD	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS109A
SN74ALS109AD.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS109A
SN74ALS109AN	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS109AN
SN74ALS109AN.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS109AN
SN74ALS109ANSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS109A
SN74ALS109ANSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS109A
SN74AS109AD	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS109A
SN74AS109AD.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS109A
SN74AS109AN	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS109AN
SN74AS109AN.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS109AN
SN74AS109ANSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS109A
SN74AS109ANSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS109A

-55 to 125

N/A for Pkg Type

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8400001EA SNJ54ALS109AJ



SNJ54ALS109AJ.A

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Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	(3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SNJ54ALS109AFK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	84000012A SNJ54ALS 109AFK
SNJ54ALS109AFK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	84000012A SNJ54ALS 109AFK
SNJ54ALS109AJ	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8400001EA SNJ54ALS109AJ

Nο

SNPB

Active

25 | TUBE

Production

CDIP (J) | 16

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN54ALS109A, SN74ALS109A:

● Catalog : SN74ALS109A

• Military : SN54ALS109A

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS109ANSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
SN74AS109ANSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

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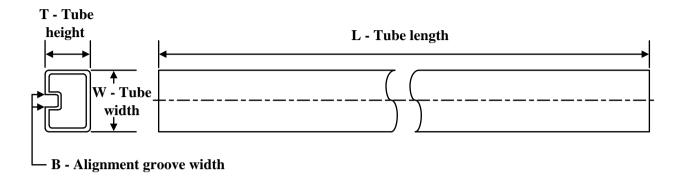
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS109ANSR	SOP	NS	16	2000	353.0	353.0	32.0
SN74AS109ANSR	SOP	NS	16	2000	353.0	353.0	32.0



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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
84000012A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/37102B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/37102B2A.A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/37102B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
SN74ALS109AD	D	SOIC	16	40	507	8	3940	4.32
SN74ALS109AD.A	D	SOIC	16	40	507	8	3940	4.32
SN74ALS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS109AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS109AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS109AD	D	SOIC	16	40	507	8	3940	4.32
SN74AS109AD.A	D	SOIC	16	40	507	8	3940	4.32
SN74AS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS109AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS109AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS109AN.A	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54ALS109AFK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54ALS109AFK.A	FK	LCCC	20	55	506.98	12.06	2030	NA



SOP



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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